SCAS067A - D3349, JULY 1989 - REVISED APRIL 1993

- Inputs Are TTL-Voltage Compatible
- 8-Line to 1-Line Multiplexers Can Perform as: Boolean Function Generators, Parallel-to-Serial Converters, Data Source Selectors
- Flow-Through Architecture Optimizes PCB Layout
- Center-Pin V_{CC} and GND Configurations Minimize High-Speed Switching Noise
- EPIC™ (Enhanced-Performance Implanted CMOS) 1-μm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Package Options Include Plastic Small-Outline Packages and Standard Plastic 300-mil DIPs

description

This monolithic data selector/multiplexer provides full binary decoding to select one-of-eight data sources. The strobe input $\overline{(G)}$ must be at a low logic level to enable the inputs. A high level at the strobe terminal forces the W output high and the Y output low.

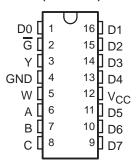
The 74ACT11151 is characterized for operation from – 40°C to 85°C.

FUNCTION TABLE

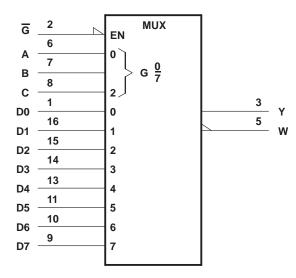
	I	OUTI	PUTS		
S	ELEC.	T	STROBE	V	w
С	В	Α	G	ı	VV
Х	Χ	Χ	Н	L	Н
L	L	L	L	D0	D ₀
L	L	Н	L	D1	D ₁
L	Н	L	L	D2	D ₂
L	Н	Н	L	D3	D 3
Н	L	L	L	D4	D4
Н	L	Н	L	D5	D ₅
Н	Н	L	L	D6	D ₆
Н	Н	Н	L	D7	D7

H = high level, L = low level, X = irrelevant D0, D1, ... D7 = the level of the respective D input

D OR N PACKAGE (TOP VIEW)



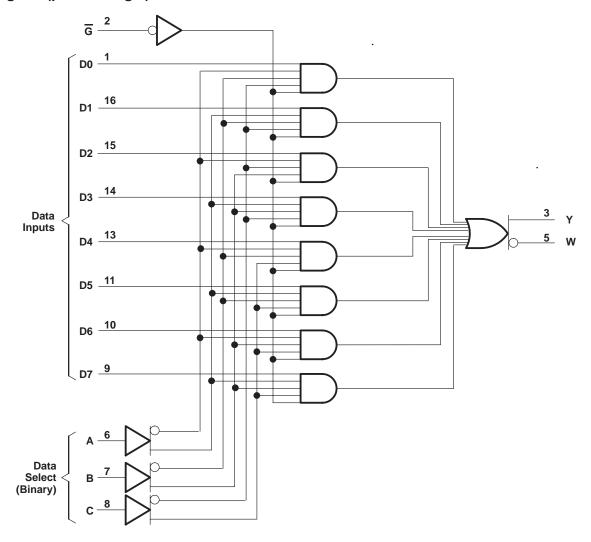
logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	
Input voltage range, V _I (see Note 1)	\dots -0.5 V to V _{CC} + 0.5 V
Output voltage range, V _O (see Note 1)	-0.5 V to $V_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	± 20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	$\dots \dots \pm 50 \text{ mA}$
Continuous output current, $I_O(V_O = 0 \text{ to } V_{CC})$	± 50 mA
Continuous current through V _{CC} or GND	± 100 mA
Storage temperature range	– 65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	MAX	UNIT
Vcc	Supply voltage	4.5	5.5	V
VIH	High-level input voltage	2		V
VIL	Low-level input voltage		8.0	V
٧ _I	Input voltage	0	VCC	V
Vo	Output voltage	0	VCC	V
IOH	High-level output current		-24	mA
loL	Low-level output current		24	mA
Δt/Δν	Input transition rise or fall rate	0	10	ns/V
TA	Operating free-air temperature	- 40	85	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST SOURITIONS	T _A		_A = 25°C	;				
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	UNIT	
	- FO A	4.5 V	4.4			4.4			
	IOH = - 50 μA	5.5 V	5.4			5.4			
Vон	04.04	4.5 V	3.94			3.8		V	
	I _{OH} = - 24 mA	5.5 V	4.94			4.8			
	$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85			
V _{OL}		4.5 V			0.1		0.1		
	I _{OL} = 50 μA	5.5 V			0.1		0.1		
	04.04	4.5 V			0.36		0.44	V	
	I _{OL} = 24 mA	5.5 V			0.36		0.44		
	$I_{OL} = 75 \text{ mA}^{\dagger}$	5.5 V					1.65		
lį	$V_I = V_{CC}$ or GND	5.5 V			± 0.1		±1	μΑ	
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80	μΑ	
Δl _{CC} ‡	One input at 3.4 V, Other inputs at GND or V _{CC}	5.5 V			0.9		1	mA	
Ci	V _I = V _{CC} or GND	5 V		3.5				pF	

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

[‡] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V to VCC.



NOTE 1: The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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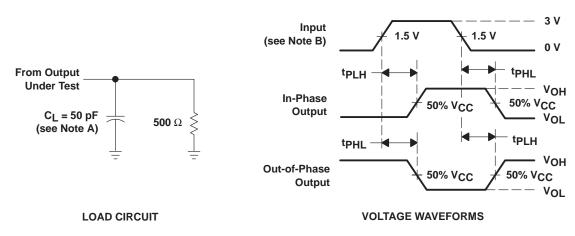
switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	T,	4 = 25°C	;		MAY	
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	UNIT
t _{PLH}	A B an C	V	3.6	6.8	9.9	3.6	11	
^t PHL	A, B, or C	Y	3.1	6.7	9.5	3.1	10.5	ns
t _{PLH}		14/	2.9	6.3	9	2.9	10	
t _{PHL}	A, B, or C	W	2.7	6.3	9.3	2.7	10.4	ns
t _{PLH}	Any D	V	3.2	5.7	7.5	3.2	8.3	
^t PHL		Υ	2.2	5.2	8	2.2	8.8	ns
^t PLH	4 5	W	2.1	4.7	7.3	2.1	7.8	20
^t PHL	Any D	VV	2.7	5.1	6.9	2.7	7.6	ns
t _{PLH}	ĪG	V	1.5	3.7	5.8	1.5	6.3	
t _{PHL}	G	Υ	2.1	4.0	5.6	2.1	6.2	ns
t _{PLH}	ĪG	14/	2.5	4.4	6.1	2.5	6.7	
^t PHL	G	W	1.7	4.1	6.4	1.7	6.9	ns

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd} Power dissipation capacitance	$C_L = 50 \text{ pF}, \qquad f = 1 \text{ MHz}$	56	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50~\Omega$, $t_f = 3~ns$, $t_f = 3~ns$.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms







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PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
74ACT11151D	OBSOLETE	SOIC	D	16	TBD	Call TI	Call TI
74ACT11151DR	OBSOLETE	SOIC	D	16	TBD	Call TI	Call TI
74ACT11151DR	OBSOLETE	SOIC	D	16	TBD	Call TI	Call TI
74ACT11151N	OBSOLETE	PDIP	N	16	TBD	Call TI	Call TI
74ACT11151N	OBSOLETE	PDIP	N	16	TBD	Call TI	Call TI

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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74ACT11151DR	OBSOLETE	SOIC	D	16	TBD	Call TI	Call TI
74ACT11151N	OBSOLETE	PDIP	N	16	TBD	Call TI	Call TI
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